## LM2743

## N－Channel FET Synchronous Buck Regulator Controller for Conversion from 3．3V

## General Description

The LM2743 is a high－speed，N－Channel synchronous buck regulator controller with a $2 \%, 0.6 \mathrm{~V}$ feedback reference volt－ age intended to make down conversion from 3.3 V to as low as 0.6 V easy．A fixed－frequency voltage－mode PWM control architecture is used，that is adjustable from 50 kHz to 2 MHz through an external resistor．This wide range of PWM fre－ quencies gives the power supply designer the flexibility to make tradeoffs among component size，cost，noise and efficiency．The power MOSFETs can run on a separate 1V to 16 V （Input Voltage， $\mathrm{V}_{\text {IN }}$ ）（Note 2）rail while the regulator is biased from a 3 V to 6 V （IC Input Voltage， $\mathrm{V}_{\mathrm{Cc}}$ ）， 2 mA rail． A power－good flag，precision shutdown threshold and soft start features make power supply tracking and sequencing easy． The LM2743 employs output under－voltage and over－voltage flag，and current limit．Current limit is achieved by monitoring the voltage drop across the on resistance of the low－side MOSFET．The adaptive non－overlapping MOSFET gate driv－ ers help avoid potential shoot－through problems while main－ taining high efficiency．Both high－side and low－side MOS－ FETs are the lower cost N－Channel type，and the IC can accept a bootstrap structure to saturate the high－side MOS－ FET for highest efficiency．

## Features

－MOSFET input voltage $\left(\mathrm{V}_{\text {IN }}\right)$ from 1 V to 16 V （Note 2）
－IC input voltage（ $\mathrm{V}_{\mathrm{CC}}$ ）from 3 V to 6 V
－Output voltage adjustable down to 0.6 V
－Power good flag and output enable
■ Output over－voltage and under－voltage flag
－FB voltage： $2 \%$ over temperature
－Current limit without series sense resistor
－Adjustable soft start
－Tracking and sequencing with shutdown and soft start pins
－Switching frequency from 50 kHz to 2 MHz
－TSSOP－14 package

## Applications

－3．3V Buck Regulation
－Set－Top Boxes／Home Gateways
－Core Logic Regulators
■ High－Efficiency Buck Regulation

## Typical Application



## Connection Diagram



## Pin Description

BOOT (Pin 1) - Supply rail for the N-channel MOSFET gate drive. The voltage should be at least one gate threshold $\left(\mathrm{V}_{\mathrm{GS}(\mathrm{th})}\right)$ above the regulator input voltage $\left(\mathrm{V}_{\mathrm{IN}}\right)$ to properly turn on the high-side FET.

LG (Pin 2) - Gate drive for the low-side N-channel MOSFET. This signal is interlocked with HG (Pin 14) to avoid a shootthrough problem.
PGND (Pins 3, 13) - Ground for low-side FET drive circuitry. Connect to system ground.
SGND (Pin 4) - Ground for signal level circuitry. Connect to system ground.
$\mathrm{V}_{\mathrm{CC}}$ (Pin 5) Supply rail for the controller.
PWGD (Pin 6) - Power good pin. This is an open drain output. The pin is pulled low when the chip is in undervoltage flag (UVF), over-voltage flag (OVF), or UVLO mode. During normal operation, this pin is connected to $\mathrm{V}_{\mathrm{CC}}$ or other low voltage source through a pull-up resistor ( $\mathrm{R}_{\text {pull }}$ up).
$I_{\text {SEN }}$ (Pin 7) - Current limit threshold setting. This sources a fixed $40 \mu \mathrm{~A}$ current. A resistor of appropriate value should be connected between this pin and the drain of the low-side FET.
EAO (Pin 8) - Output of the error amplifier. The voltage level on this pin is compared with an internally generated ramp signal to determine the duty cycle. This pin is necessary for compensating the control loop.

SS (Pin 9) - Soft start and track pin. A $10 \mu \mathrm{~A}$ current is sourced from this pin. This pin is connected to the noninverting input of the error amplifier during soft start, or any time the voltage is below the reference. To track power supplies connect a resistor divider (smaller than $10 \mathrm{k} \Omega$ for better precision) from the output of the master supply directly to the SS pin. To limit the inrush current of a single power supply, place a capacitor to ground (see Application Information/Start Up for appropriate capacitance value). This pin should not be forced before $\overline{\mathrm{SD}}$ or $\mathrm{V}_{\mathrm{CC}}$ (above the UVLO).
FB (Pin 10) - This is the inverting input of the error amplifier, which is used for sensing the output voltage and compensating the control loop. The FB current is negligible.
FREQ (Pin 11) - The switching frequency ( $\mathrm{F}_{\mathrm{osc}}$ ) is set by connecting a resistor ( $\mathrm{R}_{\text {FADJ }}$ ) between this pin and ground.
$\overline{\mathbf{S D}}$ (Pin 12) - IC shutdown pin. To assure proper IC start-up the SD pin should not be left floating. When this pin is pulled low the chip turns both, high and low, sides off. While this pin is low, the IC will not start up. This pin features a precision threshold for power supply sequencing, as well as a lower threshold to ensure minimal quiescent current.
HG (Pin 14) - Gate drive for the high-side N-channel MOSFET. This signal is interlocked with LG (Pin 2) to avoid a shoot-through problem.

| Absolute Maximum Ratings (Note 1) | Lead Temperature |  |
| :---: | :---: | :---: |
| If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications. | (soldering, 10sec) | $260^{\circ} \mathrm{C}$ |
|  | Infrared or Convection (20sec) | $235{ }^{\circ} \mathrm{C}$ |
|  | ESD Rating (Note 3) | 2 kV |
| $\mathrm{V}_{\mathrm{CC}}$ ( 7V |  |  |
| BOOT Voltage 21 V | Operating Ratings |  |
| All other pins $\quad \mathrm{V}_{\mathrm{Cc}}+0.3 \mathrm{~V}$ |  |  |
| Junction Temperature $150^{\circ} \mathrm{C}$ | IC Input Voltage ( $\mathrm{V}_{\mathrm{cc}}$ ) | 3 V to 6V |
| Storage Temperature $\quad-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | Junction Temperature Range | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Soldering Information | Thermal Resistance ( $\theta_{\text {JA }}$ ) | $155^{\circ} \mathrm{C} / \mathrm{W}$ |

## Electrical Characteristics

$V_{C C}=3.3 \mathrm{~V}$ unless otherwise indicated. Typicals and limits appearing in plain type apply for $T_{A}=T_{J}=+25^{\circ} \mathrm{C}$. Limits appearing in boldface type apply over full Operating Temperature Range. Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {FB }}$ | FB Pin Voltage | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ | 0.612 | 0.6 | 0.588 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | 0.612 | 0.6 | 0.588 |  |
| $\mathrm{V}_{\mathrm{ON}}$ | UVLO Thresholds | Rising Falling |  | $\begin{aligned} & \hline 2.76 \\ & 2.42 \end{aligned}$ |  | V |
| $\mathrm{I}_{\text {Q } V c c ~}$ | Operating $\mathrm{V}_{\mathrm{CC}}$ Current | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}, \mathrm{SD}=3.3 \mathrm{~V} \\ & \mathrm{Fsw}=600 \mathrm{kHz} \end{aligned}$ | 1 | 1.5 | 2.1 | mA |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{SD}=3.3 \mathrm{~V} \\ & \mathrm{Fsw}=600 \mathrm{kHz} \end{aligned}$ | 1 | 1.7 | 2.1 |  |
|  | Shutdown $\mathrm{V}_{\mathrm{CC}}$ Current (Note 4) | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{SD}=0 \mathrm{~V}$ | 0 | 110 | 185 | $\mu \mathrm{A}$ |
| $\mathrm{t}_{\text {PWGD1 }}$ | PWGD Pin Response Time | FB Voltage Going Up |  | 6 |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\text {PWGD2 }}$ | PWGD Pin Response Time | FB Voltage Going Down |  | 6 |  | $\mu \mathrm{s}$ |
| $\mathrm{I}_{\text {SS-ON }}$ | SS Pin Source Current | SS Voltage = 0V | 7 | 10 | 14 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {ss-oc }}$ | SS Pin Sink Current During Over Current | SS Voltage = 0V |  | 90 |  | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {SEN-TH }}$ | $I_{\text {SEN }}$ Pin Source Current Trip Point |  | 25 | 40 | 55 | $\mu \mathrm{A}$ |

## ERROR AMPLIFIER

| GBW | Error Amplifier Unity Gain <br> Bandwidth |  | 9 |  | MHz |
| :---: | :--- | :--- | :---: | :---: | :---: |
| G | Error Amplifier DC Gain |  |  | 106 |  |
| SR | Error Amplifier Slew Rate |  |  | 3.2 |  |
| $\mathrm{I}_{\text {EAO }}$ | EAO Pin Current Sourcing and | $\mathrm{V}_{\text {EAO }}=1.5, \mathrm{FB}=0.55 \mathrm{~V}$ | $\mathrm{~V} / \mathrm{\mu s}$ |  |  |
|  | Sinking Capability | $\mathrm{V}_{\text {EAO }}=1.5, \mathrm{FB}=0.65 \mathrm{~V}$ | 2.6 |  | m |
| $\mathrm{~V}_{\text {EA }}$ | Error Amplifier Maximum Swing | Minimum <br>  | Maximum | 9.2 |  |

Electrical Characteristics (Continued)
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ unless otherwise indicated. Typicals and limits appearing in plain type apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{J}=+25^{\circ} \mathrm{C}$. Limits appearing in boldface type apply over full Operating Temperature Range. Datasheet $\mathrm{min} / \mathrm{max}$ specification limits are guaranteed by design, test, or statistical analysis.

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| GATE DRIVE |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{Q} \text {-BOOT }}$ | BOOT Pin Quiescent Current | BOOTV $=12 \mathrm{~V}, \mathrm{EN}=0$ |  | 18 | 90 | $\mu \mathrm{A}$ |
| $\mathrm{R}_{\mathrm{DS} 1}$ | Top FET Driver Pull-Up ON resistance | BOOT-SW = 5V@350mA |  | 3 |  | $\Omega$ |
| $\mathrm{R}_{\mathrm{DS} 2}$ | Top FET Driver Pull-Down ON resistance |  |  | 2 |  | $\Omega$ |
| $\mathrm{R}_{\text {DS3 }}$ | Bottom FET Driver Pull-Up ON resistance |  |  | 3 |  | $\Omega$ |
| $\mathrm{R}_{\mathrm{DS} 4}$ | Bottom FET Driver Pull-Down ON resistance |  |  | 2 |  | $\Omega$ |
| OSCILLATOR |  |  |  |  |  |  |
| Fosc | PWM Frequency | $\mathrm{R}_{\text {FADJ }}=813.2 \mathrm{k} \Omega$ |  | 50 |  | kHz |
|  |  | $\mathrm{R}_{\text {FADJ }}=117.6 \mathrm{k} \Omega$ |  | 300 |  |  |
|  |  | $\mathrm{R}_{\text {FADJ }}=54.4 \mathrm{k} \Omega$ | 475 | 600 | 725 |  |
|  |  | $\mathrm{R}_{\text {FADJ }}=18.8 \mathrm{k} \Omega$ |  | 1400 |  |  |
|  |  | $\mathrm{R}_{\text {FADJ }}=10.8 \mathrm{k} \Omega$ |  | 2000 |  |  |
| D | Max Duty Cycle | $\begin{aligned} & \mathrm{f}_{\mathrm{PWM}}=300 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{PWM}}=600 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & 90 \\ & 85 \\ & \hline \end{aligned}$ |  | \% |
| LOGIC INPUTS AND OUTPUTS |  |  |  |  |  |  |
| $\mathrm{V}_{\text {StBY-IH }}$ | Standby High Trip Point | $\mathrm{FB}=0.575 \mathrm{~V}, \mathrm{BOOTV}=3.3 \mathrm{~V}, \mathrm{EN}=$ 0 V to 3.3 V |  | 0.756 | 1.1 | V |
| $\mathrm{V}_{\text {STBY-IL }}$ | Standby Low Trip Point | $\begin{aligned} & \mathrm{FB}=0.575 \mathrm{~V}, \mathrm{BOOTV}=3.3 \mathrm{~V}, \mathrm{EN}= \\ & 3.3 \mathrm{~V} \text { to } 0 \mathrm{~V} \end{aligned}$ | 0.232 | 0.562 |  | V |
| $\mathrm{V}_{\text {SD-IH }}$ | $\overline{\text { SD }}$ Pin Logic High Trip Point | $\mathrm{FB}=0.575 \mathrm{~V}, \mathrm{BOOTV}=3.3 \mathrm{~V}, \mathrm{EN}=$ 0 V to 3.3 V |  | 1 | 1.3 | V |
| $\mathrm{V}_{\text {SD-IL }}$ | $\overline{\text { SD Pin Logic Low Trip Point }}$ | $\mathrm{FB}=0.575 \mathrm{~V}, \mathrm{BOOTV}=3.3 \mathrm{~V}, \mathrm{EN}=$ 3.3V to 0V | 0.8 | 1.1 |  | V |
| $\mathrm{V}_{\text {PWGD-TH-LO }}$ | PWGD Pin Trip Points | FB Voltage Going Down | 0.408 | 0.434 | 0.457 | V |
| $\mathrm{V}_{\text {PWGD-TH-HI }}$ | PWGD Pin Trip Points | FB Voltage Going Up | 0.677 | 0.710 | 0.742 | V |
| $\mathrm{V}_{\text {PWGD-HYS }}$ | PWGD Hysteresis | FB Voltage Going Down FB Voltage Going Up |  | $\begin{aligned} & 60 \\ & 90 \\ & \hline \end{aligned}$ |  | mV |

Note 1: Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating ratings indicate conditions for which the device operates correctly. Opearting Ratings do not imply guaranteed performance limits.
Note 2: The power MOSFETs can run on a separate 1 V to 16 V rail (Input voltage, $\mathrm{V}_{\mathrm{IN}}$ ). Low range of $\mathrm{V}_{\mathbb{I N}}$ greatly depends on selection of the external MOSFET.
Note 3: The human body model is a 100 pF capacitor discharged through a 1.5 k resistor into each pin.
Note 4: Shutdown $\mathrm{V}_{\mathrm{CC}}$ current goes to zero amps after 20 seconds.

Typical Performance Characteristics


20095240
Efficiency ( $\mathrm{V}_{\text {Out }}=3.3 \mathrm{~V}$ )
$\mathrm{V}_{\mathrm{cc}}=5 \mathrm{~V}, \mathrm{~F}_{\mathrm{sw}}=300 \mathrm{kHz}$


OUTPUT CURRENT (A)
20095241
$\mathrm{V}_{\mathrm{cc}}$ Operating Current plus BOOT Current vs Frequency FDS689A FET ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )


Efficiency ( $\mathrm{V}_{\text {Out }}=2.5 \mathrm{~V}$ )
$\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}, \mathrm{~F}_{\mathrm{sw}}=300 \mathrm{kHz}$



TEMPERATURE $\left({ }^{\circ} \mathrm{C}\right)$
20095261
BOOT Pin Current vs Temperature for BOOT Voltage $=3.3 \mathrm{~V}$
$F_{\text {sw }}=300 \mathrm{kHz}$, FDS689A FET, No-Load


Typical Performance Characteristics (Continued)


20095243

Internal Reference Voltage vs Temperature


Frequency vs Temperature



20095244
$\mathrm{R}_{\text {FADJ }}$ vs Frequency 50 kHz to $2 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


Output Voltage vs Output Current


OUTPUT CURRENT (A)

Typical Performance Characteristics (Continued)

Switch Waveforms (HG Rising)
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}, \mathrm{C}_{\mathrm{SS}}=12 \mathrm{nF}, \mathrm{F}_{\text {Sw }}=300 \mathrm{kHz}$


Start-Up (No-Load)

$$
\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OUT}}=1.2 \mathrm{~V}
$$

$$
\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}, \mathrm{C}_{\mathrm{SS}}=12 \mathrm{nF}, \mathrm{~F}_{\mathrm{Sw}}=300 \mathrm{kHz}
$$


$1 \mathrm{~ms} / \mathrm{DIV}$
20095248
Shutdown (Full-Load)
$\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}, \mathrm{C}_{\mathrm{SS}}=12 \mathrm{nF}, \mathrm{F}_{\mathrm{SW}}=300 \mathrm{kHz}$


Switch Waveforms (HG Falling)
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}, \mathrm{C}_{\mathrm{sS}}=12 \mathrm{nF}, \mathrm{F}_{\mathrm{Sw}}=300 \mathrm{kHz}$


100 ns/DIV
20095247
Start-Up (Full-Load)
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}, \mathrm{C}_{\mathrm{SS}}=12 \mathrm{nF}, \mathrm{F}_{\mathrm{Sw}}=300 \mathrm{kHz}$

$1 \mathrm{~ms} /$ DIV
20095249
Load Transient Response ( $\mathrm{I}_{\text {Out }}=0 \mathrm{~A}$ to 4 A )
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$


Typical Performance Characteristics (Continued)

Load Transient Response ( $\mathrm{I}_{\text {OUT }}=4 \mathrm{~A}$ to 0 A )
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$C_{s s}=12 n F, F_{s w}=300 \mathrm{kHz}$

$40 \mu \mathrm{~s} /$ DIV
20095252
Line Transient Response ( $\mathrm{V}_{\mathrm{IN}}=3 \mathrm{~V}$ to 6 V )
$\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$
$\mathrm{I}_{\text {Out }}=2 \mathrm{~A}, \mathrm{~F}_{\text {Sw }}=300 \mathrm{kHz}$

$100 \mu \mathrm{~s} / \mathrm{DIV}$

## Load Transient Response

$\mathrm{V}_{\text {cc }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.2 \mathrm{~V}$ $C_{s s}=12 n F, F_{s w}=300 \mathrm{kHz}$

$100 \mu \mathrm{~s} / \mathrm{DIV}$
20095253
Line Transient Response ( $\mathrm{V}_{\mathrm{IN}}=6 \mathrm{~V}$ to 3 V )



## Application Information

## THEORY OF OPERATION

The LM2743 is a voltage-mode, high-speed synchronous buck regulator with a PWM control scheme. It is designed for use in set-top boxes, thin clients, DSL/Cable modems, and other applications that require high efficiency buck converters. It has power good (PWGD) flag, output shutdown ( $\overline{\mathrm{SD}}$ ), UVLO mode, and over-voltage flag (OVF) and under- voltage flag (UVF) features. The over-voltage and under-voltage signals are OR gated to drive the power good signal. If this signal is pulled low, the high side is off and low side if on, but only if the duty cycle is less then maximum. Current limit is achieved by sensing the voltage $\mathrm{V}_{\mathrm{DS}}$ across the low side FET. During current limit the high side gate is turned off and the low side gate is turned on. A $90 \mu \mathrm{~A}$ source discharges the soft start capacitor (reducing max. duty cycle) until the current is under control.

## START UP

When $\mathrm{V}_{\mathrm{CC}}$ exceeds 2.76 V and the shutdown pin ( $\overline{\mathrm{SD}}$ ) sees a logic high, the internal fixed $10 \mu \mathrm{~A}$ source begins charging the soft start capacitor. During this time the output of the error amplifier is allowed to rise with the voltage of the soft start capacitor. This capacitor, $\mathrm{C}_{\mathrm{SS}}$, determines soft start time, and can be calculated approximately by:

$$
C_{S S}=\frac{t_{\mathrm{SS}}}{4 \times 10^{4}}
$$

During soft start the power good flag is forced low and it is released when the voltage reaches a set value as shown in Figure 1. At this point the chip enters normal operation mode, the power good flag is released, and the OVF and UVF functions begin to monitor $\mathrm{V}_{\text {OUT }}$.

Application Information (Continued)


FIGURE 1. Start-Up Behavior

## NORMAL OPERATION

While in normal operation mode, the LM2743 regulates the output voltage by controlling the duty cycle of the high side and low side FETs.

The equation governing output voltage is:

$$
0.6=\frac{R_{F B 1}}{R_{F B 1}+R_{F B 2}} V_{\mathrm{OUT}}
$$

The PWM frequency is adjustable between 50 kHz and 2 MHz and is set by an external resistor, $\mathrm{R}_{\text {FADJ }}$, between the FREQ pin and ground. The resistance needed for a desired frequency is approximately:

$$
\mathrm{R}_{\mathrm{FADJ}}=10^{12} \mathrm{a}_{2}\left(\frac{1}{\mathrm{~F}_{\mathrm{OSC}}(\mathrm{~Hz})}\right)^{2}+10^{7} \mathrm{a}_{1}\left(\frac{1}{\mathrm{~F}_{\mathrm{OSC}}(\mathrm{~Hz})}\right)+10^{2} \mathrm{a}_{0}[\mathrm{k} \Omega]
$$

where $\mathrm{a}_{2}=0.206375, \mathrm{a}_{1}=3.691525, \mathrm{a}_{0}=(-0.076875)$ are the coefficients, $\mathrm{F}_{\text {Osc }}$ is the frequency in Hz , and $\mathrm{R}_{\text {FADJ }}$ is the resistance in $k \Omega$.

## SS/TRACK

When the LM2743 is used for sequencing purposes, some care has to be taken. Once the shutdown voltage goes above $\mathrm{V}_{\text {STBY-IH }}$, a $17 \mu \mathrm{~A}$ pull-up current is activated as shown in Figure 2. This current is used to create an internal hysteresis ( 170 mV ); however, high external impedances will affect the $\overline{\mathrm{SD}}$ pin level as well. The external impedance must be lower than $10 \mathrm{k} \Omega$ to work properly without glitching the quiescent current of the chip. In that scenario the SS current will turn on and off during the glitching or most likely no switching will occur at all, due to the SS voltage being very low.


FIGURE 2. $\overline{\text { SD }}$ Pin Logic
The LM2743 is also adequate for tracking purposes through the SS/TRACK pin. The tracking circuit, in the design examples below, contains a Master Power Supply with $\mathrm{V}_{\text {OUT } 1}=$ 5 V and an LM2743 with $\mathrm{V}_{\text {OUT2 }}=1.8 \mathrm{~V}$.
Three cases are described:

1. Both output voltages, $\mathrm{V}_{\text {OUT1 }}$ and $\mathrm{V}_{\text {OUT2 }}$, rise together, reaching their final values at the same time,
2. Both output voltages rise together at the same rate until $\mathrm{V}_{\text {OUT2 }}=1.8 \mathrm{~V}$, and finally
3. Output voltage $\mathrm{V}_{\text {OUT2 }}$ starts rising 3.24 ms after $\mathrm{V}_{\text {OUT1 }}$ starts.
The calculation of the feedback resistors Figure 3 for all cases is based on the Tracking Equation. Since $\mathrm{V}_{\mathrm{FB}}=0.6 \mathrm{~V}$, $\mathrm{V}_{\text {OUT } 2}=1.8 \mathrm{~V}$, and $\mathrm{R}_{\text {FB2 }}=10 \mathrm{k} \Omega$, then the $\mathrm{R}_{\text {FB1 }}$ becomes $5 \mathrm{k} \Omega$.

## Case 1: Rise together

Both, $\mathrm{V}_{\text {OUT1 }}$ and $\mathrm{V}_{\text {OUT2 }}$, start rising, and reach their nominal values at the same time as shown in Figure 4. This means that $\mathrm{V}_{\text {OUT2 }}$ rises at slower rate then $\mathrm{V}_{\text {OUT1 }}$.


FIGURE 3. Block Diagram of Case 1

$$
\mathrm{V}_{\mathrm{SS}}=\mathrm{V}_{\text {OUT } 1}{ }^{*}\left(\mathrm{R}_{3} /\left(\mathrm{R}_{3}+\mathrm{R}_{4}\right)\right)
$$

## Application Information (Continued)

$\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\text {OUT2 }}{ }^{*}\left(\mathrm{R}_{\mathrm{FB} 2} /\left(\mathrm{R}_{\mathrm{FB} 1}+\mathrm{R}_{\mathrm{FB} 2}\right)\right)$
Since $V_{S S}=V_{F B}=0.6 \mathrm{~V}$, then
Tracking Equation

$$
V_{\mathrm{OUT} 2}=\mathrm{V}_{\mathrm{OUT} 1} \times \frac{\mathrm{R}_{3}}{\mathrm{R}_{3}+\mathrm{R}_{4}} \times \frac{\mathrm{R}_{\mathrm{FB} 1}+\mathrm{R}_{\mathrm{FB} 2}}{\mathrm{R}_{\mathrm{FB} 2}}
$$

The total value of the track resistor divider (Figure 3), $\mathrm{R}_{3}$ and $R_{4}$, should be set below $10 k \Omega$ for better precision. Let $\mathrm{R} 4=1 \mathrm{~K}$, for $\mathrm{V}_{\text {OUT } 1}=5 \mathrm{~V}$ and $\mathrm{V}_{\text {OUT } 2}=1.8 \mathrm{~V}, \mathrm{R}_{3}=136 \Omega$.


FIGURE 4. Timing Behavior of Case 1

Case 2: Rise together until $\mathrm{V}_{\text {OUT2 }}=1.8 \mathrm{~V}$


FIGURE 5. Block Diagram of Case 2
$\mathrm{V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{FB}}=0.6 \mathrm{~V}$,
$\mathrm{V}_{\text {OUT } 1}=\mathrm{V}_{\text {OUT } 2}=1.8 \mathrm{~V}$
For $R_{4}=1 \mathrm{k} \Omega, R_{3}=500 \Omega$ (from Tracking Equation).
The soft start reaches 0.6 V at $\mathrm{V}_{\text {Out } 1}$ equal 1.8 V .
For $\mathrm{V}_{\text {OUt } 1}>1.8 \mathrm{~V}$, $\mathrm{V}_{\text {OUt2 }}$ stays in regulation at 1.8 V .

Case 3: $\mathrm{V}_{\text {out } 2}$ starts rising 3.0 ms after $\mathrm{V}_{\text {out } 1}$
Assuming $\mathrm{V}_{\text {OUT1 }}$ slew rate $\mathrm{SR}_{\text {VsD }}=1 \mathrm{~V} / \mathrm{ms}$ and voltage divider ratio $1: 3\left(R_{3}=500 \Omega\right.$ and $\left.R_{4}=1 \mathrm{k} \Omega\right)$, the $V_{\text {SD }}$ slew rate equals $\mathrm{SR}_{\mathrm{VSD}}=0.333 \mathrm{~V} / \mathrm{ms}$. During the delay time $\mathrm{V}_{\mathrm{SD}}$ raises to $1.0 \mathrm{~V}\left(\mathrm{~V}_{\overline{\mathrm{SD}}-\mathrm{IH}}\right)$ as shown in Figure 8 . The delay time is calculated from :

$$
\begin{gathered}
\mathrm{t}_{\mathrm{DELAY}}=\mathrm{V} \overline{\mathrm{SD}-\mathrm{IH}} / \mathrm{SR}_{\mathrm{VSD}} \\
\mathrm{t}_{\mathrm{DELAY}}=1.0(\mathrm{~V}) / 0.333(\mathrm{~V} / \mathrm{ms})=3.0 \mathrm{~ms}
\end{gathered}
$$



FIGURE 7. Block Diagram of Case 3

Application Information
(Continued)


FIGURE 8. Timing Behavior of Case 3
If the tracking through SS/TRACK pin is not used, a capacitor to ground is needed to limit the inrush current.

## MOSFET GATE DRIVERS

The LM2743 has two gate drivers designed for driving N -channel MOSFETs in a synchronous mode. Power for the drivers is supplied through the BOOT pin. For the high side gate (HG), to fully turn the top FET on, the BOOT voltage must be at least one $\mathrm{V}_{\text {GS(th) }}$ greater than $\mathrm{V}_{\text {IN }}\left(\mathrm{V}_{\text {BOOT }} \geq 2 \mathrm{~V}+\right.$ $\mathrm{V}_{\mathrm{IN}}$ ). This voltage can be supplied from a separate voltage source or from a local charge pump structure, the bootstrap.
A charge pump can be built using a diodes and small capacitors, as shown in the below figures. The capacitor serves to maintain enough voltage between the top FET gate and source to control the device even when the top FET is on and its source has risen up to the input voltage level.
The LM2743 gate drives use a BiCMOS design. Unlike some other bipolar control ICs, the gate drivers have rail-to-rail swing, ensuring no spurious turn-on due to capacitive coupling.
The LM2743 can operate its internal circuitry at the $\mathrm{V}_{\mathrm{CC}}$ range from 3.0 V to 6.0 V . However, the external FETs may operate more efficiently with higher gate drive voltage. Figure 9 shows a typical bootstrap method where the voltage applied to the FETs is $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{D}}$.


FIGURE 9. Bootstrap Configuration 1
This means that if $\mathrm{V}_{\mathrm{Cc}}$ is 3.0 V , the gate drive for the FETs is approximately 2.5 V . This voltage could be too low to fully turn the FET on. As a result $I^{2} \mathrm{R}$ losses could be higher than expected.
In the next bootstrap configuration (Figure 10) the voltage applied to the high side FET is $\mathrm{V}_{C C}-2 \mathrm{~V}_{\mathrm{D}}$ and to the low side FET is $\mathrm{V}_{\mathrm{cc}}-\mathbf{2} \mathrm{V}_{\mathrm{D}}+\mathrm{V}_{\mathrm{IN}}$.


FIGURE 10. Bootstrap Configuration 2
If $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\text {IN }}$ are both 3.0 V , then 5 V is developed at BOOT pin and the low side FET can be driven fully on. The high side FET however may have difficulty turning on since the applied gate drive is only 2 V in this case.
The Figure 11 shows next example of bootstrap configuration. In this case the low gate drive voltage on the top FET is resolved. Now the gate drive on both, the low and high, side FETs is $\mathbf{V}_{\mathbf{c c}}-\mathbf{3} \mathbf{V}_{\mathbf{D}}+\mathbf{V}_{\mathrm{IN}}$.

## Application Information



## FIGURE 11. Bootstrap Configuration 3

At an input voltage of 3 V both, the high and low, side FETs are driven with about 4.5 V .
The decision on which configuration to use depends on the desired output current and operating frequency. At high currents and low frequencies, configuration 3 (Figure 11) is recommended. For low currents and high frequencies, configuration 1 (Figure 9) may work well.

## POWER GOOD SIGNAL

The power good signal is the OR-gated flag representing over-voltage and under-voltage conditions. If the feedback pin (FB) voltage is about $18 \%$ over its nominal value (VWGD-тн-нI $=0.710 \mathrm{~V}$ ) or falls about $30 \%$ below its nominal value $\left(\mathrm{V}_{\text {PWGD-TH-LO }}=0.434 \mathrm{~V}\right)$ the power good flag goes low. At about $118 \%$ of $\mathrm{V}_{\mathrm{FB}}$ the converter turns off the high side gate and turns on the low side gate. However, at about $70 \%$ of $\mathrm{V}_{\mathrm{FB}}$ the converter goes to maximum duty cycle and the high and low sides are still switching. The power good flag will return to logic high whenever the feedback pin voltage is between $70 \%$ and $118 \%$ of 0.6 V .

## UVLO

The 2.76 V turn-on threshold on $\mathrm{V}_{\mathrm{CC}}$ has a built in hysteresis of 400 mV . Therefore, if $\mathrm{V}_{\mathrm{cc}}$ drops below 2.42 V , the chip enters UVLO mode. UVLO consists of turning off the top and bottom FETs, and remaining in that condition until $\mathrm{V}_{\mathrm{CC}}$ rises above 2.76 V . As with shutdown, the soft start capacitor is discharged through a FET, ensuring that the next start-up will be smooth.

## CURRENT LIMIT

Current limit is realized by sensing the voltage across the low side FET while it is on. The $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of the FET is a known value, and the voltage across the FET can be found from:

$$
V_{D S}=I_{D S} * R_{D S(O N)}
$$

The current limit is determined by an external resistor, $\mathrm{R}_{\mathrm{CS}}$, connected between the switch node and the $I_{\text {SEN }}$ pin. A constant current of $40 \mu \mathrm{~A}$ is forced through $\mathrm{R}_{\mathrm{CS}}$, causing a fixed voltage drop. This fixed voltage is compared against
$\mathrm{V}_{\mathrm{DS}}$ and if the latter is higher, the current limit of the chip has been reached. The $\mathrm{R}_{\mathrm{CS}}$ can be found by using the following:

$$
\mathrm{R}_{\mathrm{CS}}=\mathrm{R}_{\mathrm{DS}(\mathrm{ONLOW})}(\Omega) \times \frac{\mathrm{I}_{\mathrm{LIM}}(\mathrm{~A})}{40 \mu(\mathrm{~A})}
$$

where resistance $R_{D S(O N)}$ is taken from MOSFET's datasheet ( $\mathrm{R}_{\mathrm{DS} \text { (ON Low) }}=13 \mathrm{~m} \Omega$ ) and current limit ( $\mathrm{I}_{\text {LIM }}$ ) value is calculated from equation.

$$
\mathrm{I}_{\mathrm{LIM}}=\mathrm{I}_{\mathrm{OUT}}+0.5 \frac{\left(\mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{OUT}}\right) \times \mathrm{V}_{\mathrm{OUT}}}{\mathrm{Lx} \mathrm{~V}_{\mathrm{CC}} \times \mathrm{F}_{\mathrm{OSC}}}
$$

where: $L$ is the inductance and $F_{\text {Osc }}$ is the PWM frequency. Because current sensing is done across the low side FET, no minimum high side on-time is necessary. In the current limit mode the LM2743 will turn the high side off and the keep low side on for a time as long as necessary. The chip also discharges the soft start capacitor through a fixed $90 \mu \mathrm{~A}$ source. This way, smooth ramping up of the output voltage as with a normal soft start is ensured. The output of the LM2743 internal error amplifier is limited by the voltage on the soft start capacitor. Hence, discharging the soft start capacitor reduces the maximum duty cycle ( D ) of the controller. During severe current limit, this reduction in duty cycle will reduce the output voltage if the current limit conditions last for an extended period of time.

## UVF/OVF

The output under-voltage flag (UVF) and over-voltage flag (OVF) mechanisms engage at about $70 \%$ and $118 \%$ of the target output voltage, respectively. In the UVF case, the LM2743 will turn off the high side switch and turn on the low side switch and dischrage the soft start capacitor through the MOSFET switch. However, in the OVF the converter goes to maximum duty cycle and the high and low sides are still switching. The chip remains in this state until the shutdown pin has been pulled to a logic low and then released. The UVF function is masked only during the initial charge of the soft start capacitor, when voltage is first applied to the $\mathrm{V}_{\mathrm{CC}}$ pin. The power good flag goes low during this time, giving a logic-level warning signal.

## SHUT DOWN

To assure proper IC start-up, shutdown pin ( $\overline{\mathrm{SD}})$ should not be left floating. For Normal Operation this pin should be connected to $\mathrm{V}_{\mathrm{Cc}}$ or other low voltage source (see Electrical Characteristics table).
If the shutdown pin $\overline{\mathrm{SD}}$ is pulled low, the LM2743 discharges the soft start capacitor through a MOSFET switch. The high and the low side switches are turned off. The LM2743 remains in this state until $\overline{\mathrm{SD}}$ is released.

## DESIGN CONSIDERATIONS

The following is a design procedure for all the components needed to create the Typical Application Circuit. The designed $3.3 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{CC}}\right)$ to $1.2 \mathrm{~V}\left(\mathrm{~V}_{\text {OUT }}\right)$ converter is capable of delivering 4A with an efficiency of $89 \%$ at switching frequency of 300 kHz . The same procedures can be followed to create many other designs with varies input and output voltages, and load current.

## Application Information <br> (Continued)

## Input Capacitor

The input capacitors in a Buck switching converter are subjected to high stress due to the input current square waveform. Hence input capacitors are selected for their ripple current capability and their ability to withstand the heat generated as that ripple current runs through their ESR. Input rms ripple current is approximately:

$$
I_{\text {Rus_RIP }}=I_{\text {OUT }} \times \sqrt{D(1-D)}
$$

where D is the duty cycle.
The power dissipated by each input capacitor is:

$$
\left.P_{\mathrm{CAP}}=\frac{\left(I_{\mathrm{RMS}}\right.}{} \mathrm{RIP}\right)^{2} \times \mathrm{ESR}
$$

where, n is the number of capacitors, and ESR is the equivalent series resistance of $\mathrm{C}_{\mathrm{IN} 1}$.
The equation indicates that power loss in each capacitor decreases rapidly as the number of input capacitors increases. The worst-case ripple for a Buck converter occurs during full load and when the duty cycle (D) is 0.5 . For design $3.3 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{CC}}\right)$ to $1.2 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{OUT}}\right)$ the duty cycle is 0.364 . With a 4 A maximum load the ripple current is around 2 A . The Sanyo 20SP120M aluminum electrolytic capacitor works fine here. It has a ripple current rating of 3 A and maximum ESR of $24 \mathrm{~m} \Omega$ at 100 kHz . The power dissipated by the Sanyo's capacitor is then 0.088 W . Other options for input and output capacitors include MLCC, Tantalum, OSCON, SP, and POSCAPS.

Support Components: Capacitors ( $\mathrm{C}_{\mathrm{IN} 2}, \mathrm{C}_{\mathrm{cc}}, \mathrm{C}_{\mathrm{BOOT}}$, $\mathrm{C}_{\mathrm{SS}}$ ), Resistors ( $\mathbf{R}_{\mathrm{Cc}}, \mathbf{R}_{\mathrm{CS}}, \mathbf{R}_{\text {FADJ }}, \mathbf{R}_{\text {PuLL-UP }}$ ), and Schottky Diode ( $\mathrm{D}_{1}$ )
$\mathrm{C}_{\mathrm{IN2} 2}$ - the MOSFET's input capacitor is high frequency bypass device designed to filter harmonics of the switching frequency and input noise. $0.1 \mu \mathrm{~F}-1 \mu \mathrm{~F}$ ceramic capacitor with a sufficient voltage rating will work well in almost any case.
$\mathbf{R}_{\mathbf{C C}}, \mathbf{C}_{\mathbf{C C}}$, and $\mathbf{C}_{\text {воот }}$ - bypass resistor and bypass capacitors are standard filter components designed to ensure smooth DC voltage for the chip supply and for the bootstrap structure, if it is used. Recommended values: $\mathrm{R}_{\mathrm{CC}}=10 \Omega$, $C_{C C}=0.1 \mu \mathrm{~F}$, and $\mathrm{C}_{\text {BOOT }}=0.1 \mu \mathrm{~F}$.
$\mathbf{R}_{\text {PULL-UP }}$ - this is a standard pull-up resistor for the opendrain power good signal (PWGD). The recommended value: $100 \Omega$ : connected to $\mathrm{V}_{\mathrm{Cc}}$. If this feature is not necessary, the resistor can be omitted.
$D_{1}$ - Schottky diode should be used for the bootstrap. It allows the minimum drop for both, high and low side drivers. The MBR0520 works well here.
$\mathbf{R}_{\mathbf{C s}}$ - resistor used to set the current limit. Since the design calls for a peak current magnitude ( $\mathrm{l}_{\mathrm{OUT}}+0.5^{*} \Delta \mathrm{l}_{\mathrm{OUT}}$ ) of 4.8 A , a safe setting would be 6A. (This is below the saturation current of the output inductor, which is 7.8 A .) Following the equation from the Current Limit section, use a $1.5 \mathrm{k} \Omega$ resistor.
$\mathbf{R}_{\text {FADJ }}$ - this resistor is used to set the switching frequency ( $F_{\text {OSC }}$ ) of the chip. The resistor value is calculated from equation in Normal Operation section. To obtain the switching frequency of $300 \mathrm{kHz}, 110 \mathrm{k} \Omega, 1 \%$ resistor is needed.
$\mathbf{C}_{\text {Ss }}$ - the soft start capacitor depends on the user requirements and is calculated based on the equation from the Start Up section. For a 7 ms delay, a 12 nF capacitor will be suitable.

## Output Inductor

The output inductor forms the first half of the power stage in a Buck converter. It is responsible for smoothing the square wave created by the switching action and for controlling the output current ripple ( $\Delta \mathrm{I}_{\mathrm{OUT}}$ ). The inductance is chosen by selecting between tradeoffs in efficiency and response time. The smaller the output inductor, the more quickly the converter can respond to transients in the load current. However, as shown in the efficiency calculations, a smaller inductor requires a higher switching frequency to maintain the same level of output current ripple. An increase in frequency can mean increasing loss in the FETs due to the charging and discharging of the gates. Generally the switching frequency is chosen so that conduction loss outweighs switching loss. The equation for output inductor selection is:

$$
\begin{gathered}
\mathrm{L}=\frac{\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\text {OUT }}}{\Delta \mathrm{I}_{\text {OUT }} \times \mathrm{F}_{\mathrm{OSC}}} \times \mathrm{D} \\
\mathrm{~L}=\frac{3.3 \mathrm{~V}-1.2 \mathrm{~V}}{0.4 \mathrm{~A} \times 4 \mathrm{~A} \times 300 \mathrm{kHz}} \times \frac{1.2 \mathrm{~V}}{3.3 \mathrm{~V}} \\
\mathrm{~L}=16 \mu \mathrm{H}
\end{gathered}
$$

Plugging in the values for output current ripple, input voltage, output voltage, switching frequency, and assuming a 40\% peak-to-peak output current ripple yields an inductance of $1.6 \mu \mathrm{H}$. The output inductor must be rated to handle the peak current (also equal to the peak switch current), which is (lout $\left.+0.5^{*} \Delta \mathrm{l}_{\text {OUT }}\right) 4.8 \mathrm{~A}$ for a 4A design. The Coilcraft DO3316P222 P is $2.2 \mu \mathrm{H}$, is rated to 7.4 A rms , and has a direct current resistance ( $\mathrm{DCR}_{\text {IOUT }}$ ) of $11 \mathrm{~m} \Omega$.

## Output Capacitor

The output capacitor forms the second half of the power stage of a Buck switching converter. It is used to control the output voltage ripple ( $\Delta \mathrm{V}_{\text {OUT }}$ ) and to supply load current during fast load transients.
In this example the output current is 4 A and the expected type of capacitor is an aluminum electrolytic, as with the input capacitors. Other possibilities include ceramic, tantalum, and solid electrolyte capacitors, however the ceramic type often do not have the large capacitance needed to supply current for load transients, and tantalums tend to be more expensive than aluminum electrolytic. Aluminum capacitors tend to have very high capacitance and fairly low ESR, meaning that the ESR zero, which affects system stability, will be much lower than the switching frequency. The large capacitance means that at switching frequency, the ESR is dominant, hence the type and number of output capacitors is selected on the basis of ESR. One simple formula to find the maximum ESR based on the desired output voltage ripple, $\Delta \mathrm{V}_{\text {OUT }}$ and the designed output current ripple, $\Delta \mathrm{l}_{\text {OUT }}$, is:

$$
\mathrm{ESR}_{\mathrm{MAX}}=\frac{\Delta \mathrm{V}_{\mathrm{OUT}}}{\Delta \mathrm{I}_{\mathrm{OUT}}}
$$

## Application Information (Continued)

In this example, in order to maintain a $2 \%$ peak-to-peak output voltage ripple and a $40 \%$ peak-to-peak inductor current ripple, the required maximum ESR is $15 \mathrm{~m} \Omega$. The Sanyo 4SP560M aluminum electrolytic capacitor will give an equivalent ESR of $14 \mathrm{~m} \Omega$. The capacitance of $560 \mu \mathrm{~F}$ is enough to supply even severe load transients.

## MOSFETs

MOSFETs are the critical parts of any switching controller. Both, the control high side FET and the synchronous low side FET, have a direct impact on the system efficiency.
In this case the target efficiency for typical application circuit is about $89 \%$. This variable will determine which MOSFET is acceptable to use for the design.
Loss from the capacitors, inductors, and IC come to about 0.27 W . This leaves about 0.33 W for the FET switching, conduction, and gate charging losses to meet the target efficiency. All the losses are detailed in the Efficiency section.
The switching loss is particularly difficult to estimate because it depends on many factors. When the load current is more than about 1 or 2 amps, conduction losses outweigh the switching and gate charging losses. This allows FET selection based on the $R_{\text {DS(ON) }}$ of the FET. After adding the FET switching and gate charging losses about 0.27W leaves for conduction losses. When plugged MOSFET, the FDS6898A with a typical $R_{\mathrm{DS}(\mathrm{ON})}$ of $13 \mathrm{~m} \Omega$, into the equation from Efficiency section for $\mathrm{P}_{\mathrm{CND}}$ the loss come to be about 0.27 W .

## Control Loop Components

The Typical Application Circuit has been compensated to improve the DC gain and bandwidth. The result of this compensation is better line and load transient responses. For the LM2743, the top feedback divider resistor, $\mathrm{R}_{\text {FB2 }}$, is also a part of the compensation. For the 3.3 V to 1.2 V at 4 A design, the values are:
$\mathrm{C}_{\mathrm{C} 1}=27 \mathrm{pF}, \mathrm{C}_{\mathrm{C} 2}=1200 \mathrm{nF}, \mathrm{C}_{\mathrm{C} 3}=3300 \mathrm{pF}, \mathrm{R}_{\mathrm{C} 1}=40.2 \mathrm{k} \Omega$, $R_{\mathrm{C} 2}=2.55 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{FB} 2}=10 \mathrm{k} \Omega$.
These values give a phase margin of $53^{\circ}$ and a bandwidth of 80kHz.

## EFFICIENCY CALCULATIONS

A reasonable estimation of the efficiency of a switching buck controller can be obtained by adding together the Output Power ( $\mathrm{P}_{\text {OUT }}$ ) loss and the Total Power ( $\mathrm{P}_{\text {TOTAL }}$ ) loss:

$$
\eta=\frac{P_{\text {OUT }}}{P_{\text {OUT }}+P_{\text {TOTAL }}} \times 100 \%
$$

The Output Power (Pout) for theTypical Application Circuit design is $(1.2 \mathrm{~V}$ * 4 A$)=4.8 \mathrm{~W}$. The Total Power ( $\mathrm{P}_{\text {TOtaL }}$ ), with an efficiency calculation to complement the design, is shown below.
The majority of the power losses are due to low and high side of MOSFET's losses. The losses in any MOSFET are group of switching ( $\mathrm{P}_{\mathrm{SW}}$ ) and conduction losses $\left(\mathrm{P}_{\mathrm{CND}}\right)$.

$$
\begin{gathered}
P_{F E T}=P_{S W}+P_{C N D}=61.38 \mathrm{~mW}+270 \mathrm{~mW} \\
P_{F E T}=331.4 \mathrm{~mW}
\end{gathered}
$$

FET Switching Loss ( $\mathrm{P}_{\mathrm{sw}}$ )

$$
\begin{gathered}
\mathrm{P}_{\mathrm{SW}}=\mathrm{P}_{\mathrm{SW}(\mathrm{ON})}+\mathrm{P}_{\mathrm{SW}(\mathrm{OFF})} \\
\mathrm{P}_{\mathrm{SW}}=0.5 * \mathrm{~V}_{\mathrm{CC}}{ }^{*} \mathrm{I}_{\mathrm{OUT}} *\left(\mathrm{t}_{\mathrm{r}}+\mathrm{t}_{\mathrm{f}}\right)^{*} \mathrm{~F}_{\mathrm{OSC}}
\end{gathered}
$$

$$
\begin{gathered}
P_{\mathrm{SW}}=0.5 \times 3.3 \mathrm{~V} \times 4 \mathrm{~A} \times 300 \mathrm{kHz} \times 31 \mathrm{~ns} \\
P_{\mathrm{SW}}=61.38 \mathrm{~mW}
\end{gathered}
$$

The FDS6898A has a typical turn-on rise time $\mathrm{t}_{\mathrm{r}}$ and turn-off fall time $t_{f}$ of 15 ns and 16 ns , respectively. The switching losses for this type of dual N-Channel MOSFETs are 0.061 W .

FET Conduction Loss ( $\mathrm{P}_{\text {CND }}$ )

$$
\begin{gathered}
\mathrm{P}_{\mathrm{CND}}=\mathrm{P}_{\mathrm{CND} 1}+\mathrm{P}_{\mathrm{CND} 2} \\
\mathrm{P}_{\mathrm{CND} 1}=\mathrm{I}^{2} \mathrm{OUT} \times \mathrm{R}_{\mathrm{DS}(\mathrm{ON})} \times k \times \mathrm{k} \\
\mathrm{P}_{\mathrm{CND} 2}=\mathrm{I}^{2} \text { OUT } \times \mathrm{R}_{\mathrm{DS}(\mathrm{ON})} \times \mathrm{k} \times(1-\mathrm{D})
\end{gathered}
$$

$R_{D S(O N)}=13 \mathrm{~m} \Omega$ and the factor is a constant value ( $k=1.3$ ) to account for the increasing $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of a FET due to heating.

$$
\begin{aligned}
& \mathrm{P}_{\mathrm{CND} 1}=(4 \mathrm{~A})^{2} \times 13 \mathrm{~m} \Omega \times 1.3 \times 0.364 \\
& \mathrm{P}_{\mathrm{CNDD}}=(4 \mathrm{~A})^{2} \times 13 \mathrm{~m} \Omega \times 1.3 \times(1-0.364) \\
& \mathrm{P}_{\mathrm{CND}}=98.42 \mathrm{~mW}+172 \mathrm{~mW}=270 \mathrm{~mW}
\end{aligned}
$$

There are few additional losses that are taken into account:
IC Operating Loss ( $\mathrm{P}_{\text {IC }}$ )

$$
P_{\mathrm{IC}}=\mathrm{I}_{\mathrm{Q}_{-} \mathrm{Vcc}} \times \mathrm{V}_{\mathrm{cc}},
$$

where $\mathrm{I}_{\mathrm{Q}-\mathrm{vcc}}$ is the typical operating $\mathrm{V}_{\mathrm{CC}}$ current

$$
P_{1 C}=1.5 \mathrm{~mA} * 3.3 \mathrm{~V}=4.95 \mathrm{~mW}
$$

FET Gate Charging Loss ( $\mathrm{P}_{\mathrm{GATE}}$ )

$$
\begin{gathered}
P_{\mathrm{GATE}}=\mathrm{n} * \mathrm{~V}_{\mathrm{CC}} * \mathrm{Q}_{\mathrm{GS}} * \mathrm{~F}_{\mathrm{OSC}} \\
\mathrm{P}_{\mathrm{GATE}}=2 \times 3.3 \mathrm{~V} \times 3 \mathrm{nC} \times 300 \mathrm{kHz} \\
\mathrm{P}_{\mathrm{GATE}}=5.94 \mathrm{~mW}
\end{gathered}
$$

The value n is the total number of FETs used and $\mathrm{Q}_{\mathrm{GS}}$ is the typical gate-source charge value, which is 3 nC . For the FDS6898A the gate charging loss is 5.94 mW .
Input Capacitor Loss ( $\mathrm{P}_{\text {CAP }}$ )

$$
\mathrm{P}_{\mathrm{CAP}}=\frac{\left(\mathrm{I}_{\mathrm{RMS} \_ \text {RIP }}\right)^{2} \times \mathrm{ESR}}{\mathrm{n}^{2}}
$$

Where,

$$
I_{\text {RMS_RIP }}=I_{\text {OUT }} \times \sqrt{D(1-D)}
$$

n is the number of capacitors, and ESR is equivalent series resistance.

$$
\begin{aligned}
& \qquad P_{\text {CAP }}=\frac{(1.924 \mathrm{~A})^{2} \times 24 \mathrm{~m} \Omega}{\mathrm{I}^{2}} \\
& \mathrm{P}_{\mathrm{CAP}}=88.8 \mathrm{~mW} \\
& \text { Output Inductor Loss }\left(\mathrm{P}_{\text {IND }}\right) \\
& \mathrm{P}_{\text {IND }}=\mathrm{I}^{2} \text { OUT } * \mathrm{DCR}_{\text {IOUT }}, \\
& \text { where } \text { DCR }_{\text {IOUT }} \text { is the direct current resistance } \\
& \mathrm{P}_{\text {IND }}=(4 \mathrm{~A})^{2} \times 11 \mathrm{~m} \Omega \\
& \mathrm{P}_{\text {IND }}=176 \mathrm{~mW}
\end{aligned}
$$

Total System Efficiency

$$
\eta=\frac{P_{\text {OUT }}}{P_{\text {OUT }}+P_{\text {TOTAL }}} \times 100 \%
$$

$$
\eta=\frac{4.8 W}{4.8 W+0.6 W}=89 \%
$$

## Example Circuits



20095232
FIGURE 12. 3.3 V to $1.8 \mathrm{~V} @ 2 \mathrm{~A}, \mathrm{~F}_{\mathrm{sw}}=300 \mathrm{kHz}$

| PART | PART NUMBER | TYPE | PACKAGE | DESCRIPTION | VENDOR |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{U}_{1}$ | LM2743 | Synchronous <br> Controller | TSSOP-14 |  | NSC |
| $Q_{1}$ | FDS6898A | Dual N-MOSFET | SO-8 | $20 \mathrm{~V}, 10 \mathrm{~m} \Omega @ 4.5 \mathrm{~V}$, <br> 16 nC | Fairchild |
| $\mathrm{D}_{1}$ | MBR0520LTI | Schottky Diode | SOD-123 |  |  |
| $\mathrm{L}_{1}$ | DO3316P-472 | Inductor |  | $4.7 \mu \mathrm{H}, 4.8 \mathrm{Arms}$ <br> $18 \mathrm{~m} \Omega$ | Coilcraft |
|  |  |  |  |  |  |
| $\mathrm{C}_{\text {IN }} 1$ |  |  |  |  |  |

Example Circuits (Continued)


FIGURE 13. 5 V to $2.5 \mathrm{~V} @ 2 \mathrm{~A}, \mathrm{~F}_{\text {sw }}=300 \mathrm{kHz}$

| PART | PART NUMBER | TYPE | PACKAGE | DESCRIPTION | VENDOR |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{U}_{1}$ | LM2743 | Synchronous Controller | TSSOP-14 |  | NSC |
| $\mathrm{Q}_{1}$ | FDS6898A | Dual N-MOSFET | SO-8 | $\begin{aligned} & \text { 20V, 10m } \Omega @ 4.5 \mathrm{~V}, \\ & 16 \mathrm{nC} \end{aligned}$ | Fairchild |
| $\mathrm{D}_{1}$ | MBR0520LTI | Schottky Diode | SOD-123 |  |  |
| $\mathrm{L}_{1}$ | DO3316P-682 | Inductor |  | $6.8 \mu \mathrm{H}, 4.4 \mathrm{Arms}, 27 \mathrm{~m} \Omega$ | Coilcraft |
| $\mathrm{C}_{\text {IN }} 1$ | 16SP100M | Aluminum Electrolytic |  | 100 $\mu \mathrm{F}, 16 \mathrm{~V}, 2.89 \mathrm{Arms}$ | Sanyo |
| $\mathrm{C}_{0} 1$ | 10SP56M | Aluminum Electrolytic |  | 56uF, 10V 1.7Arms | Sanyo |
| $\begin{aligned} & \mathrm{C}_{\mathrm{CC}}, \mathrm{C}_{\text {воот }} \\ & \mathrm{C}_{\text {IN }} 2, \mathrm{C}_{\mathrm{O}} 2 \end{aligned}$ | VJ1206Y104KXXA | Capacitor | 1206 |  | Vishay |
| $\mathrm{C}_{\mathrm{C} 3}$ | VJ0805A182KXAA | Capacitor | 805 | 1800pF, 10\% | Vishay |
| $\mathrm{C}_{\text {SS }}$ | VJ0805Y123KXXA | Capacitor | 805 | 12nF, 10\% | Vishay |
| $\mathrm{C}_{\mathrm{C} 2}$ | VJ1805A821KXAA | Capacitor | 805 | 820pF 10\% | Vishay |
| $\mathrm{C}_{\mathrm{C} 1}$ | VJ0805A330KXAA | Capacitor | 805 | 33pF, 10\% | Vishay |
| $\mathrm{R}_{\text {FB2 }}$ | CRCW08051002F | Resistor | 805 | 10.0k ${ }^{\text {1\% }}$ | Vishay |
| $\mathrm{R}_{\mathrm{FB} 1}$ | CRCW08053161F | Resistor | 805 | 3.16k ${ }^{1 \%}$ | Vishay |
| $\mathrm{R}_{\text {FADJ }}$ | CRCW08051103F | Resistor | 805 | 110k $\Omega$ 1\% | Vishay |
| $\mathrm{R}_{\mathrm{C} 2}$ | CRCW08051301F | Resistor | 805 | 1.3k $\Omega$ 1\% | Vishay |
| $\mathrm{R}_{\mathrm{CS}}$ | CRCW08057870F | Resistor | 805 | $787 \Omega$ 1\% | Vishay |
| $\mathrm{R}_{\mathrm{Cc}}$ | CRCW080510R0F | Resistor | 805 | 10.0 ${ }^{\text {1\% }}$ \% | Vishay |
| $\mathrm{R}_{\mathrm{C} 1}$ | CRCW08053322F | Resistor | 805 | $33.2 \mathrm{k} \Omega$ 1\% | Vishay |
| $\mathrm{R}_{\text {PULL-UP }}$ | CRCW08051003J | Resistor | 805 | $100 \mathrm{k} \Omega$ 5\% | Vishay |

Example Circuits (Continued)


20095234
FIGURE 14.5 V to $3.3 \mathrm{~V} @ 4 \mathrm{~A}, \mathrm{~F}_{\mathrm{Sw}}=300 \mathrm{kHz}$

| PART | PART NUMBER | TYPE | PACKAGE | DESCRIPTION | VENDOR |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{U}_{1}$ | LM2743 | Synchronous Controller | TSSOP-14 |  | NSC |
| $\mathrm{Q}_{1}$ | FDS6898A | Dual N-MOSFET | SO-8 | $\begin{aligned} & \text { 20V, 10m } \Omega @ 4.5 \mathrm{~V}, \\ & 16 \mathrm{nC} \end{aligned}$ | Fairchild |
| $\mathrm{D}_{1}$ | MBR0520LTI | Schottky Diode | SOD-123 |  |  |
| $\mathrm{L}_{1}$ | DO3316P-332 | Inductor |  | $3.3 \mu \mathrm{H}, 5.4 \mathrm{Arms} 15 \mathrm{~m} \Omega$ | Coilcraft |
| $\mathrm{C}_{\text {IN }} 1$ | 16SP100M | Aluminum Electrolytic |  | 100 F , 16V | Sanyo |
|  |  |  |  | 2.89Arms |  |
| $\mathrm{C}_{0} 1$ | 6SP220M | Aluminum <br> Electrolytic |  | 220رF, 6.3V 3.1Arms | Sanyo |
| $\begin{array}{\|l} \hline \mathrm{C}_{\mathrm{Cc}}, \mathrm{C}_{\text {воот }}, \\ \mathrm{C}_{\text {IN }} 2, \mathrm{C}_{\mathrm{O}} 2 \\ \hline \end{array}$ | VJ1206Y104KXXA | Capacitor | 1206 | 0.1 $\mu \mathrm{F}, 10 \%$ | Vishay |
| $\mathrm{C}_{\text {C3 }}$ | VJ805Y222KXXA | Capacitor | 805 | 2200pF, 10\% | Vishay |
| $\mathrm{C}_{\text {SS }}$ | VJ0805Y123KXXA | Capacitor | 805 | 12nF, 10\% | Vishay |
| $\mathrm{C}_{\mathrm{C} 2}$ | VJ805Y332KXXA | Capacitor | 805 | 3300pF 10\% | Vishay |
| $\mathrm{C}_{\mathrm{C} 1}$ | VJ0805A820KXAA | Capacitor | 805 | 82pF, 10\% | Vishay |
| $\mathrm{R}_{\text {FB2 }}$ | CRCW08051002F | Resistor | 805 | 10.0k ${ }^{\text {1 \% }}$ | Vishay |
| $\mathrm{R}_{\text {FB1 }}$ | CRCW08052211F | Resistor | 805 | $2.21 \mathrm{k} \Omega 1 \%$ | Vishay |
| $\mathrm{R}_{\text {FADJ }}$ | CRCW08051103F | Resistor | 805 | 110k $\Omega$ \% | Vishay |
| $\mathrm{R}_{\mathrm{C} 2}$ | CRCW08052611F | Resistor | 805 | $2.61 \mathrm{k} \Omega 1 \%$ | Vishay |
| $\mathrm{R}_{\mathrm{CS}}$ | CRCW08057870F | Resistor | 805 | 787 1\% | Vishay |
| $\mathrm{R}_{\mathrm{CC}}$ | CRCW080510R0F | Resistor | 805 | 10.0 $1 \%$ | Vishay |
| $\mathrm{R}_{\mathrm{C} 1}$ | CRCW08051272F | Resistor | 805 | $12.7 \mathrm{k} \Omega 1 \%$ | Vishay |
| $\mathrm{R}_{\text {PULL-UP }}$ | CRCW08051003J | Resistor | 805 | 100k $\Omega$ 5\% | Vishay |

Evaluation Board Schematic


FIGURE 15. 3.3 V to $1.2 \mathrm{~V} @ 4 \mathrm{~A}, \mathrm{~F}_{\mathrm{sw}}=300 \mathrm{kHz}$

| PART | PART NUMBER | TYPE | PACKAGE | DESCRIPTION | VENDOR |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{U}_{1}$ | LM2743 | Synchronous Controller | TSSOP-14 |  | NSC |
| $\mathrm{Q}_{1}$ | FDS6898A | Dual N-MOSFET | SO-8 | $\text { 20V,10m } @ 4.5 \mathrm{~V},$ $16 n C$ | Fairchild |
| $\mathrm{D}_{1}$ | MBR0520LTI | Schottky Diode | SOD-123 |  |  |
| $\mathrm{L}_{1}$ | DO3316P-222 | Inductor |  | $2.2 \mu \mathrm{H}, 6.1 \mathrm{Arms}$ $12 \mathrm{~m} \Omega$ | Coilcraft |
| $J_{1}$ | NOT USED |  |  |  |  |
| C12 | 20SP120M | Aluminum Electrolytic |  | $120 \mu \mathrm{~F}, 20 \mathrm{~V}$ <br> 3.1Arms | Sanyo |
| C16 | 4SP560M | Aluminum Electrolytic |  | 560رF, 4V 4Arms | Sanyo |
| $\begin{aligned} & \hline \text { C4,C5,C10, } \\ & \text { C13,C19 } \end{aligned}$ | VJ1206Y104KXXA | Capacitor | 1206 |  | Vishay |
| C11 | VJ805Y332KXXA | Capacitor | 805 | 3300pF 10\% | Vishay |
| C7 | VJ0805Y123KXXA | Capacitor | 805 | 12nF, 10\% | Vishay |

Evaluation Board Schematic (Continued)

| PART | PART NUMBER | TYPE | PACKAGE | DESCRIPTION | VENDOR |
| :--- | :--- | :--- | :--- | :--- | :--- |
| C8 | VJ1206Y122KXXA | Capacitor | 1206 | $1200 \mathrm{pF} 10 \%$ | Vishay |
| C9 | VJ0805A270KXAA | Capacitor | 805 | $27 \mathrm{pF}, 10 \%$ | Vishay |
| C1, C2, C3, C6, <br> C14, C15, C17, <br> C18, C20 | NOT USED |  |  |  |  |
|  |  |  |  |  |  |
| R6 |  |  |  |  |  |
| R7 | CRCW08051002F | Resistor | 805 | $10.0 \mathrm{k} \Omega 1 \%$ | Vishay |
| R2 | CRCW08051103F | Resistor | 805 | $110 \mathrm{k} \Omega 1 \%$ | Vishay |
| R5 | CRCW08052551F | Resistor | 805 | Vishay |  |
| R4 | CRCW08051501F | Resistor | 805 | $1.55 \mathrm{k} \Omega 1 \%$ | Vishay |
| R1 | CRCW080510R0F | Resistor | 805 | $10.0 \Omega 1 \%$ | Vishay |
| R3 | CRCW08054022F | Resistor | 805 | $40.2 \mathrm{k} \Omega 1 \%$ | Vishay |
| R11 | CRCW08050R00F | Resistor | 805 | $0 \Omega 1 \%$ | Vishay |
| R8 | CRCW08051003J | Resistor | 805 | $100 \mathrm{k} \Omega 5 \%$ | Vishay |

PCB Layout for the Evaluation
Board




Physical Dimensions inches（millimeters）unless otherwise noted


RECOMMENDED LAND PATTERN

TSSOP－14 Pin Package NS Package Number MTC14

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